Re / %

0.14

± 0.06





Ag / %

0.33

Sb / %

0.50

Pb / %

42.8

Mg / %

0.85

Method: Light Elements | PP4 12/18/2023 5:37:55 PM

Name: Plat PCB 4
Grade ID: No Match

Grade Alias:

Symbol

Conc.

U

Duration of measurement: 12.2 s (2.1/10.1)

Hf / %

0.24

 ± 0.05

AI / %

2.31

± 2.58

U	± 0.15	± 0.08	± 0.05	± 0.3	± 0.38	± 0.3	± 0.05	± 0.09
Symbol	Ga / %	As / %	Pd / %	In / %	Te / %	La / %	Ce / %	Pr / %
Conc.	0.11	1.80	.053	0.11	1.70	3.52	6.19	1.76
U	± 0.03	± 0.12	± .029	± 0.05	± 0.58	± 1.01	± 1.42	± 0.96
Symbol	Nd / %	Pt / %	Au / %	Ni / %				
Conc.	9.20	0.12	0.43	3.95				

 ± 0.05

Sn / %

23.8





Method: Light Elements | PP4 12/18/2023 5:39:03 PM

Name: Plat PCB 4. Grade ID: No Lib.

Grade Alias:

Duration of measurement: 12.2 s (2.1/10.1)

Symbol	Al / %	Zn / %	Ag / %	Ce / %	La / %	Nd / %	Pr / %	Cu / %
Conc.	10.6	4.43	.070	0.49	0.39	0.81	0.52	.022
U	± 0.6	± 0.06	± .019	± 0.13	± 0.11	± 0.25	± 0.26	± .019

Symbol	Si / %	Ni / %	Sn / %	Co / %	P/%	Pd / %	In / %	Te / %
Conc.	1.10	39.7	0.17	.024	.061	.041	.037	1.04
U	± 0.08	± 0.2	± 0.03	± .009	± .013	± .020	± .020	± 0.25



1/4/2024 2:55:50 PM



Method: Light Elements | PP4 12/18/2023 5:40:46 PM

Name: Plat PCB 4.. Grade ID: No Lib.

Grade Alias:

Duration of measurement: 12.2 s (2.1/10.1)

Symbol	AI / %	Zn / %	Mn / %	Ce / %	La / %	Nd / %	Pr / %	Cu / %
Conc.	8.72	0.87	.007	1.24	0.83	2.10	1.58	.048
U	± 0.57	± 0.05	± .007	± 0.26	± 0.20	± 0.51	± 0.50	± .033
Symbol	Si / %	Ni / %	Sn / %	Co / %	Ti / %	P/%	Pd / %	In / %
Conc.	1.39	76.1	0.25	.027	.010	.078	0.12	0.10
U	± 0.10	± 0.3	± 0.06	± .014	± .008	± .016	± 0.04	± 0.04
		T	ı	T	I	1	T	T
Symbol	Te / %							
Conc.	2.00							
U	± 0.48							